

MBR3045BCT&MBR3045HCT

30.0AMPS. SCHOTTKY BARRIER RECTIFIERS

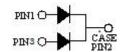
FEATURE

.High current capability
.Low forward voltage drop
.Low power loss, high efficiency
.High surge capability
.High temperature soldering guaranteed
260°C /10seconds, 0.25"(6.35mm)from case.

2 (PP) 3



TO-263-2L MBR3045BCT TO-262-3L MBR3045HCT



MECHANICAL DATA

.Case: Molded with UL-94 Class V-0 recognized

Flame Retardant Epoxy .Mounting position: any

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Parameter	Symbol	MBR3045BCT&MBR3045HCT	Units
Maximum Recurrent Peak Reverse Voltage	$V_{ m RRM}$	45	V
Maximum RMS Voltage	$V_{ m RMS}$	32	V
Maximum DC blocking Voltage	$V_{ m DC}$	45	V
Maximum Average Forward Rectified Current Per Leg	7	15.0	
at $T_C = 100$ °C Total device	$I_{ m F(AV)}$	30.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method) Per Leg	$I_{ m FSM}$	200.0	A
Typical Junction Capacitance (Note 1)	$C_{ m J}$	760	pF
Operation Junction Temperature and Storage Temperature	$T_{ m J},T_{ m STG}$	-55 to +150	°C

ELECTRICAL CHARACTERISTICS-(per leg) (T_A=25°C unless otherwise noted)

ELECTRICITE CHITTATE I ELITISTICS (per leg) (14 25 ° amess otherwise noted)						
Parameter	Symbol	Test condition	ons	Тур	Max	Units
Forward voltage drop $V_{ m F}$		T _J =25°C	$I_F=3A$	0.45		
			$I_F=5A$	0.48		
	IZ.		$I_F=15A$	0.58	0.65	V
	V _F	T _J =125°C	$I_F=3A$	0.34		v
			$I_F=5A$	0.38		
			$I_F=15A$	0.53	0.60	
Reverse leakage current $I_{ m R}$	7	T _J =25°C	$V_R=45V$		250	μА
	$I_{\rm R}$	T _J =125°C	$V_R=45V$		30	mA

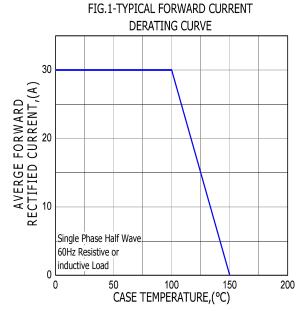
THERMAL CHARACTERISTICS(T_C=25°C unless otherwise noted)

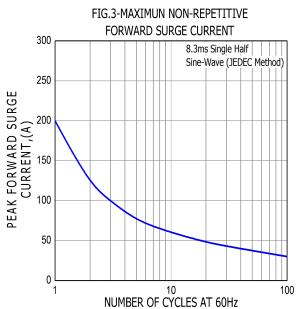
Parameter	Symbol	MBR3045BCT	MBR3045HCT	Units
Typical Thermal Resistance (Note 2)	$R_{ m (JC)}$	2.0	2.0	°C/W

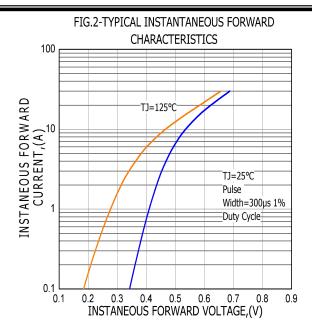
Notes:

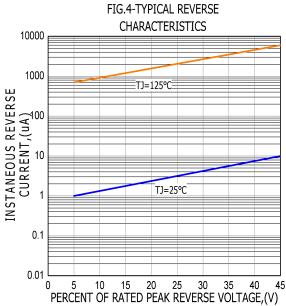
- 1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
- 2. Thermal Resistance from Junction to Case

RATING AND CHARACTERISTIC CURVE



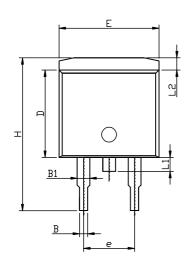


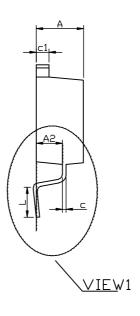


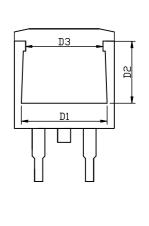


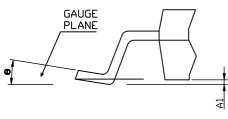


TO-263-2L PACKAGE OUTLINE

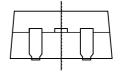




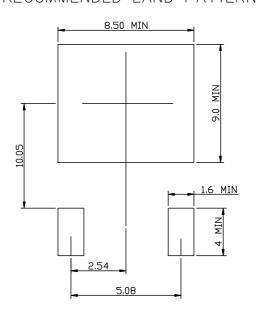








RECOMMENDED LAND PATTERN

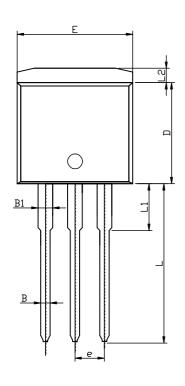


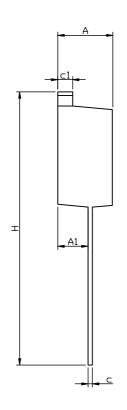
UNIT: mi		1
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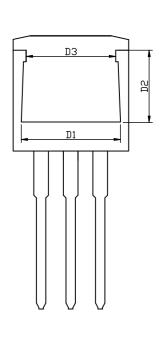
	MIN	NOM	MAX
A	4.50	4.70	4.90
A1	0.05	0.15	0.30
A2	2.45	2.60	2.70
В	0.72	0.82	0.92
B1	1.12	1.27	1.42
С	0.28	0.38	0.48
c1	1.17	1.27	1.37
D	8.46	8.66	8.86
D1	7.90	8. 10	8.40
D2	5. 50	5.70	5.90
D3	7. 10	7.30	7.50
Е	9.85	10. 15	10.45
е		5. 08BCS	
Н	14.75	15. 15	15.55
L	2.30	2.55	2.80
L1	1.20	1.40	1.60
L2	1.01	1.23	1.50
θ	0°	7°	8°

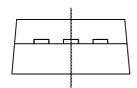


TO-262-3L PACKAGE OUTLINE

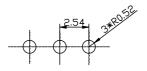








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UNIT: mm

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A	4.50	4.70	4.90
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D	8.46	8.66	8.86
D1	7.90	8. 10	8.40
D2	5. 50	5.70	5.90
D3	7. 10	7.30	7.50
E	9.85	10.15	10.45
е		2.54	
Н	23. 20	23.60	24.00
L	13. 10	13.60	14. 10
L1	3.85	4.05	4.35
L2	1.01	1.23	1.50